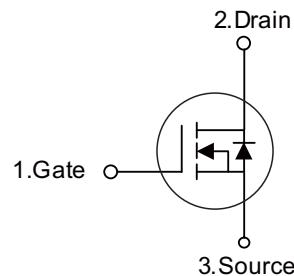


■ PRODUCT CHARACTERISTICS

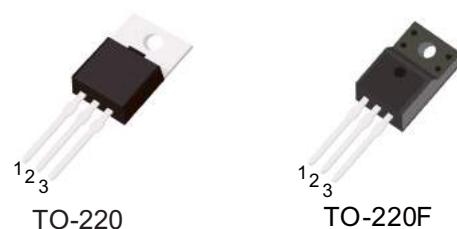
VDSS	30V
R _{DS(on)} Typ(@V _{GS} =4.5 V)	5.6mΩ
R _{DS(on)} Typ(@V _{GS} =10 V)	3.6mΩ
ID	90A

Symbol

■ DESCRIPTION

This is suitable for the most demanding DC-DC converter application where high efficiency is to be achieved.

■ FEATURES

- * R_{DS(on)}*Q_g industry's benchmark
- * Conduction losses reduced
- * Switching losses reduced
- * Low threshold device


■ ORDER INFORMATION

Order codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT90N03A	TO-220	50 pieces/Tube
N/A	MOT90N03F	TO-220F	50 pieces/Tube

■ ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{GS}	Gate-source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25°C	90	A
I _D	Drain current (continuous) at T _C =100°C	72	A
I _{DM} ⁽²⁾	Drain current (pulsed)	320	A
P _{TOT}	Total dissipation at T _C = 25°C	95	W
	Derating factor	0.63	W/°C
E _{AS} ⁽³⁾	Single pulse avalanche energy	350	mJ
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 175	°C

■ THERMAL DATA

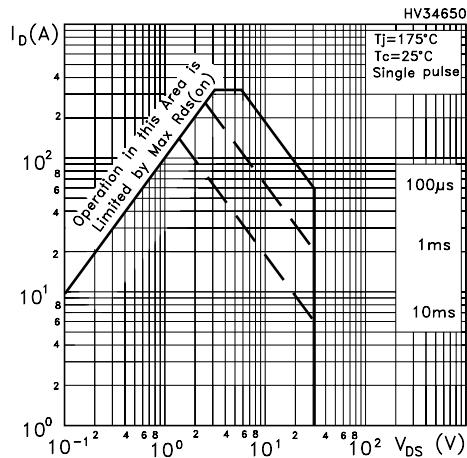
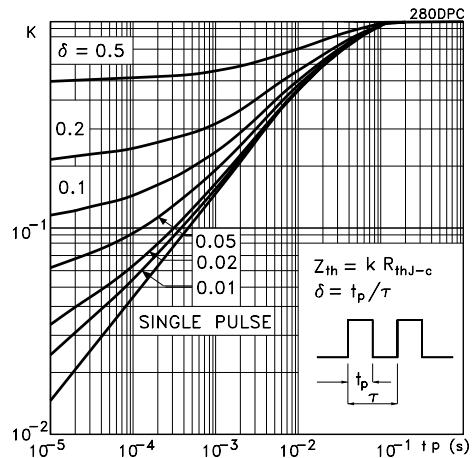
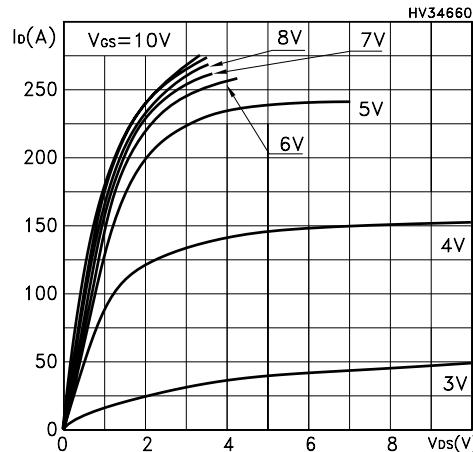
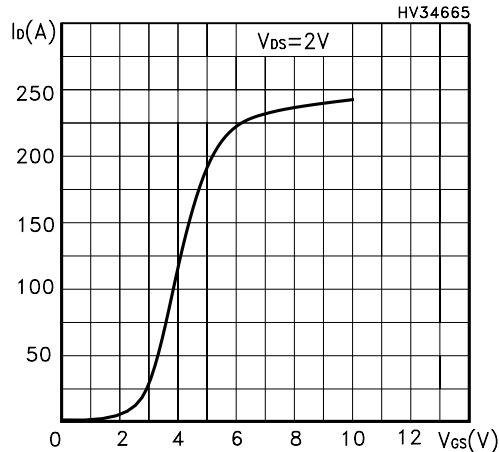
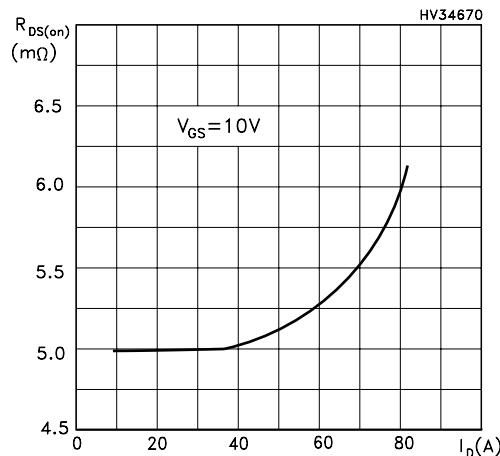
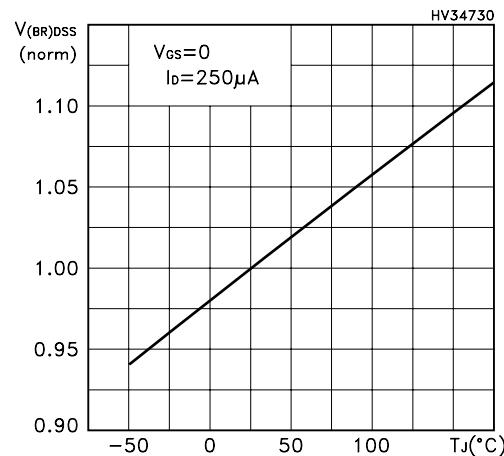
Symbol	Symbol	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	1.58	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	100	°C/W
T _j	Maximum lead temperature for soldering purpose	275	°C

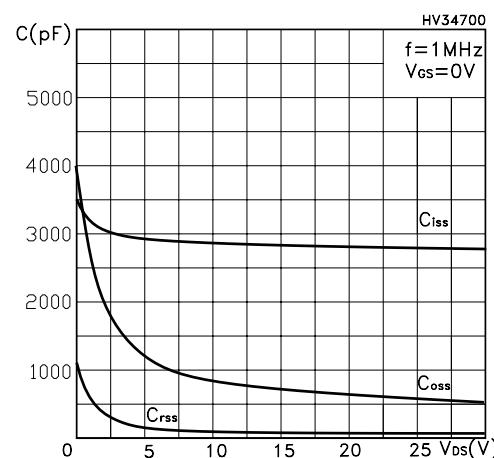
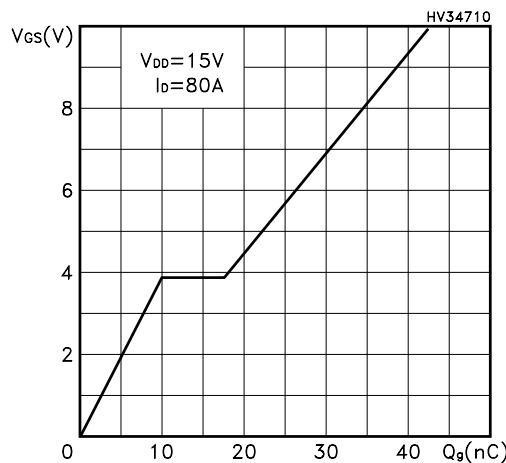
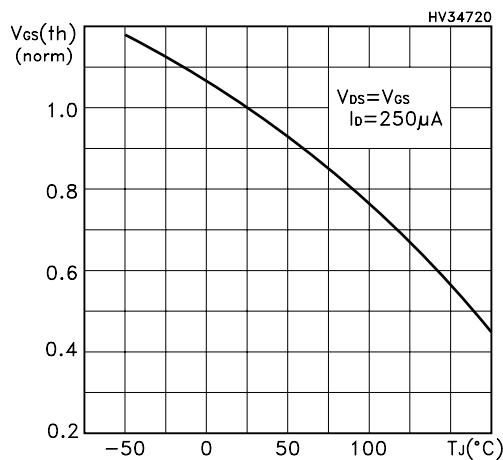
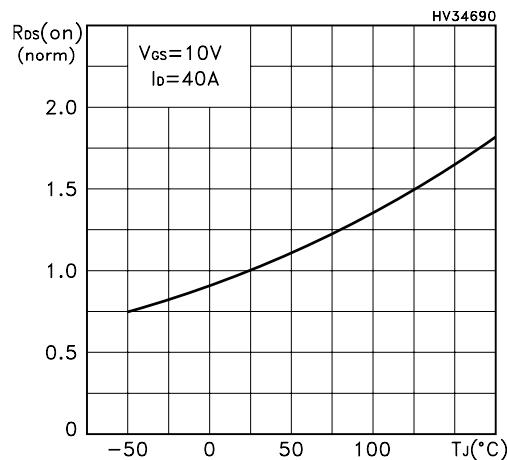
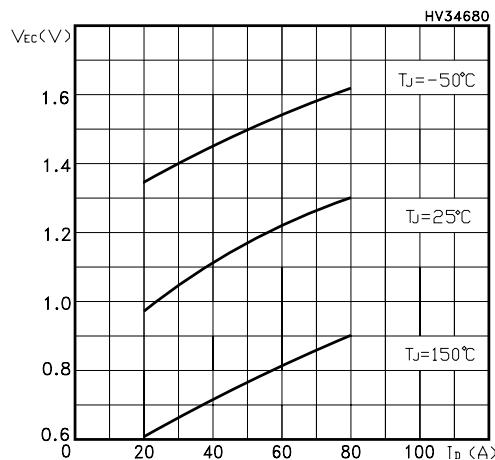
1. Value limited by wire bonding
2. Pulse width limited by safe operating area
3. Starting T_j = 25°C, I_D =40A, V_{DD} =15V

■ ELECTRICAL CHARACTERISTICS ($T_c = 25^\circ\text{C}$, unless otherwise specified)

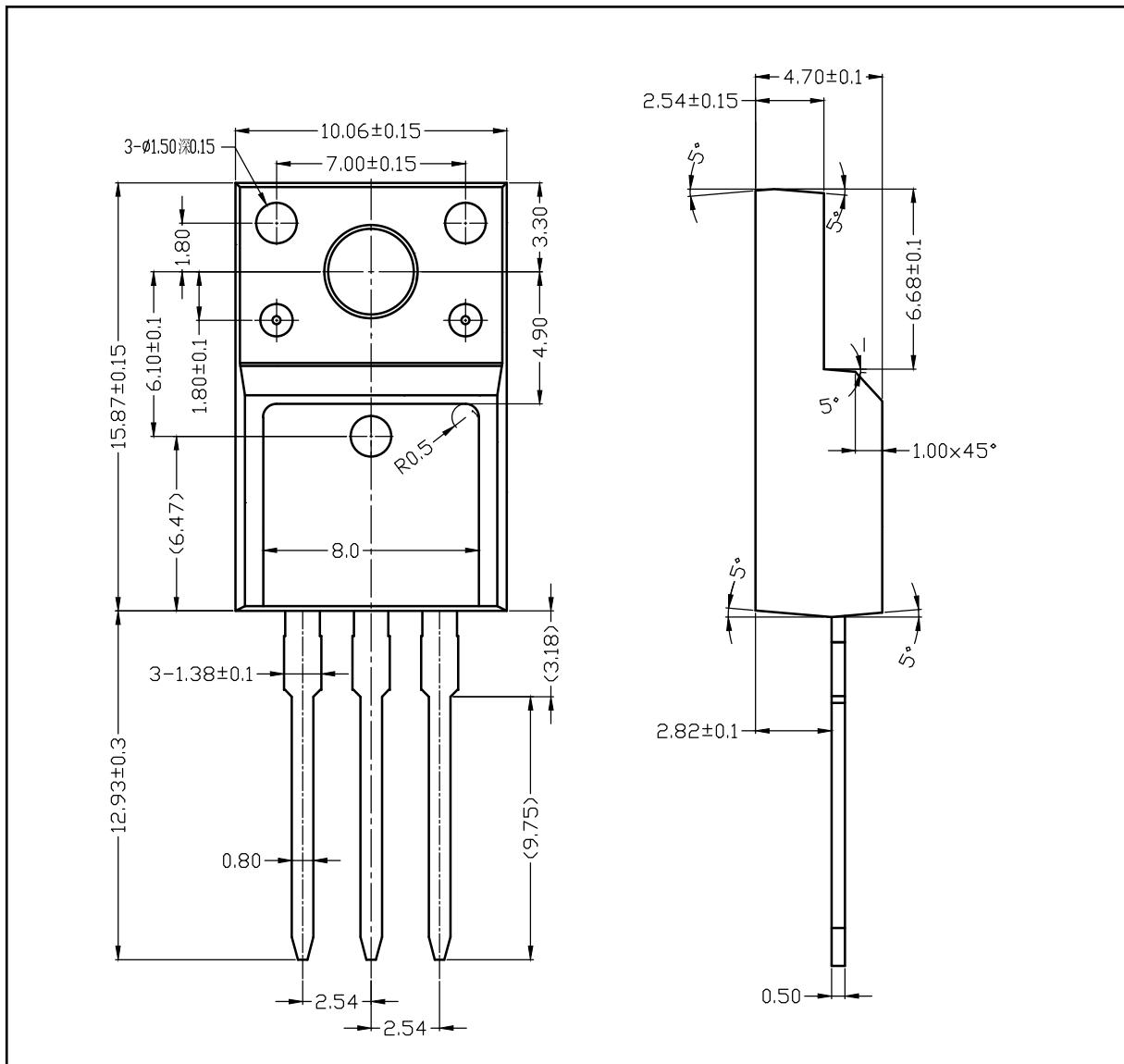
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$I_D = 250\mu\text{A}, V_{GS} = 0$	30			V
I_{DSS}	Zero gate voltage drain current ($V_{GS} = 0$)	$V_{DS} = 30\text{V}$			1	μA
		$V_{DS} = 30\text{V}, T_c = 125^\circ\text{C}$			10	μA
I_{GSS}	Gate body leakage current ($V_{DS} = 0$)	$V_{GS} = \pm 20\text{V}$			± 100	nA
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1			V
$R_{DS(\text{on})}$	Static drain-source on resistance	$V_{GS} = 10\text{V}, I_D = 40\text{A}$		3.6	4.5	$\text{m}\Omega$
		$V_{GS} = 5\text{V}, I_D = 40\text{A}$		5.6	8	
C_{iss}	Input capacitance	$V_{DS} = 25\text{V}, f = 1\text{MHz}, V_{GS} = 0$		2805		pF
C_{oss}	Output capacitance			549		pF
C_{rss}	Reverse transfer capacitance			76		pF
Q_g	Total gate charge	$V_{DD} = 15\text{V}, I_D = 80\text{A}$		22	32	nC
Q_{gs}	Gate-source charge	$V_{GS} = 5\text{V}$		10		nC
Q_{gd}	Gate-drain charge	(see Figure 13)		7		nC
R_G	Gate input resistance	f=1MHz Gate Bias Bias=0 Test Signal Level=20mV open drain		1.2		Ω
$t_{d(on)}$ t_r	Turn-on delay time Rise time	$V_{DD} = 15\text{V}, I_D = 40\text{A}, R_G = 4.7\Omega, V_{GS} = 5\text{V}$ (see Figure 12)		19		ns
				135		ns
$t_{d(off)}$ t_f	Turn-off delay time Fall time	$V_{DD} = 15\text{V}, I_D = 40\text{A}, R_G = 4.7\Omega, V_{GS} = 5\text{V}$ (see Figure 12)		24		ns
				33		ns
I_{SD}	Source-drain current				80	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)				320	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 40\text{A}, V_{GS} = 0$			1.3	V
t_{rr}	Reverse recovery time	$I_{SD} = 80\text{A}, di/dt = 100\text{A}/\mu\text{s}$		36		ns
Q_{rr}	Reverse recovery charge	$V_{DD} = 19\text{V}, T_j = 150^\circ\text{C}$		32		μC
I_{RRM}	Reverse recovery current	(see Figure 15)		1.8		A

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration=300 μs , duty cycle 1.5%

■ TYPICAL CHARACTERISTICS

Figure 1. Safe operating area

Figure 2. Thermal impedance

Figure 3. Output characteristics

Figure 4. Transfer characteristics

Figure 5. Static drain-source on resistance

Figure 6. Normalized B_{VDSS} vs temperature

■ TYPICAL CHARACTERISTICS

Figure 7. Gate charge vs gate-source voltage
Figure 8. Capacitance variations

Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature

Figure 11. Source-drain diode forward characteristics

■ TO-220F-3L PACKAGE OUTLINE DIMENSIONS





仁懋电子

MOT90N03A/90N03F
N-CHANNEL MOSFET

■ TO-220-3L PACKAGE OUTLINE DIMENSIONS

